

STEREO

IMPACT

IMPACT/PLASTIC Power Converter Requirements

LVPSRequirements_F.doc
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Document Revision Record

Rev.	Date	Description of Change	Approved By
A	2002-July-15	Preliminary Draft	-
B	2002-July-29	<ul style="list-style-type: none"> • Small changes to the SEP supply requirements from Caltech • Add PLASTIC currents & mechanical • Add SEP mechanical 	-
C	2002-Oct-17	<ul style="list-style-type: none"> • Update SEP LVPS voltages/currents • Update IDPU LVPS currents • Add IDPU LVPS Form Factor • Add SWEA connector pinout 	-
D	2002-Dec-9	<ul style="list-style-type: none"> • Add SEP connector pinouts • Fix SWEA Pinouts • Add SWEA, IDPU load capacitance • Add reference to HVPS requirements document • Remove SEPT -5.1V supply • Update SEP loads per the CDR values • Add SEP capacitive load • Update SEP form factor 	-
E	2003-Feb-25	<ul style="list-style-type: none"> • PLASTIC +/-5V -> +/-5.5V • PLASTIC loads change • Split PLASTIC 2.5V Load, change connector • Update SEP power consumption & add distribution & min/max figures • Update SEP power connector 	
F	2003-Mar-5	<ul style="list-style-type: none"> • Update SEP loads & capacitance (figures 2-1, 2-2a-c). Fig 2-1 contains has max case. • Update PLASTIC LVPS form factor (fig 2-4) 	

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1. Introduction

This document describes the requirements on the low voltage and high voltage power converters being built at UCB for STEREO. This includes low voltage converters for the IMPACT IDPU, SEP, and SWEA/STE, a low voltage converter for PLASTIC, and a high voltage converter for SIT. UCB will design, build, and test these supplies according to these requirements prior to providing them to the instrument teams.

1.1. Document Conventions

In this document, **TBD** (To Be Determined) means that no data currently exists. A value followed by **TBR** (To Be Resolved) means that this value is preliminary. In either case, the value is typically followed by a code such as UCB indicating who is responsible for providing the data, and a unique reference number.

1.2. Applicable Documents

The following reference documents include drawings and STEREO Project policies. All documents and drawings can be found on the Berkeley STEREO/IMPACT FTP site:

<http://sprg.ssl.berkeley.edu/impact/dwc/>

Or on the APL STEREO web site at:

<https://sd-forum.jhuapl.edu/stereo/>

1. Project/EMC_7881-9030_RevA - EMC requirements
2. Project/EnvSpec7381-9003RevA - Environmental specifications
3. Specifications/IDPUDesign_C - IDPU form factors & internal connectors
4. IMPACT_ICD_RevA - Spacecraft to IMPACT ICD (APL)
5. hvps_requirements_rev1 – SIT HVPS requirements

2. LVPS Requirements

The 4 low voltage power converters shall convert primary spacecraft 28V into secondary voltages as indicated in Figure 2-1.

2.1. Primary Characteristics

Each of the 4 supplies shall have a separate switched spacecraft service, as indicated in reference 4. The characteristics of the spacecraft 28V supply are indicated in reference 2 (including ground isolation requirements).

2.2. EMC

The supplies shall meet the EMC requirements called out in reference 1, in particular the conducted emissions and susceptibility requirements. Reference 4 includes a typical front end (filter) circuit for the LVPS.

2.3. Secondary Characteristics

The supplies shall provide the voltages listed in Figure 2-1. These supplies shall be regulated to +/-5% (half load to full load). High frequency (supply-generated) ripple on the secondaries shall be less than 10mV peak to peak at Max Current.

2.3.1. Digital / Analog Ground

The digital supplies (highlighted in figure 2-1) shall have a separate return from the analog supplies (not highlighted). These returns will be tied together in the instrument.

2.3.2. SEPT Supplies

The SEPT supplies are part of the SEP supply. These supplies shall have separate secondaries with separate isolated returns (both analog and digital). There are two such SEPT supplies (one for SEPT-E and one for SEPT-NS).

2.3.3. Peak Current

Figure 2-1 lists the nominal and surge current requirements. The supply shall perform within specs for loads up to at least 50% above the nominal current indicated.

2.4. Form Factor and Connector Definitions

2.4.1. IDPU LVPS

The IDPU LVPS form factor is shown in Figure 2-7. The LVPS shall have an MDM connector between the LVPS half of the tray and the other side. The mating connector shall be wired from there to the power input connector (IDPU-J1; pinout as called out in Reference 4) and the internal connector to the other boards (pinout in reference 3). Mass estimate is 400g (excluding box).

2.4.2. SWEA LVPS

The SWEA LVPS form factor is shown in figure 2-2 and 2-3. The supply shall be harnessed to a connector type MM-222-021-261-41WC (M83513/04-C11N) that mates with the DAC board via a pig-tail. This connector pinout is shown in Figure 2.8.

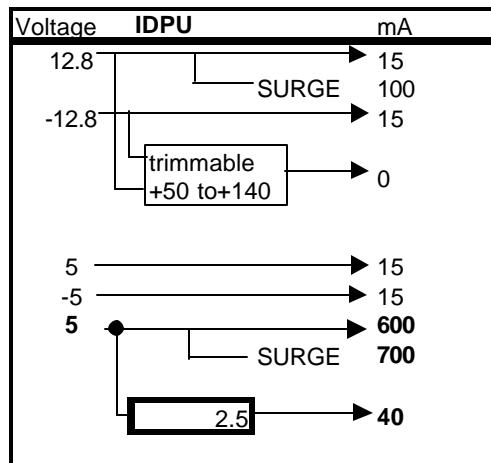
2.4.3. SEP LVPS

The SEP LVPS form factor is shown in figure 2-6. Secondary connector pinouts are shown in Figure 2-9. Primary power connector pinout is defined in reference 4. Mass estimate is 480g (including box). Figure 2.1a/b shows the SEP power flow to the various subsystems. Figure 2.1c shows the min/max power consumption for SEP. At SEP turn-on loads are at the absolute minimum: in the worst case it can take up to 4 minutes to boot; nominally it takes 1 minute. Following the turn-on boot process SEP will operate in the low-power state indefinitely.

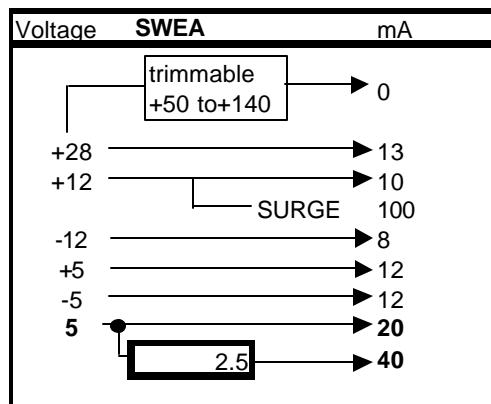
2.4.4. PLASTIC LVPS

The PLASTIC LVPS form factor is shown in figures 2-4 and 2-5. Secondary voltages are available on feed-through posts as shown. Pin assignments for the output connector are shown in figure 2-10. Pinout for the input (spacecraft) connector are TBD-PLASTIC.

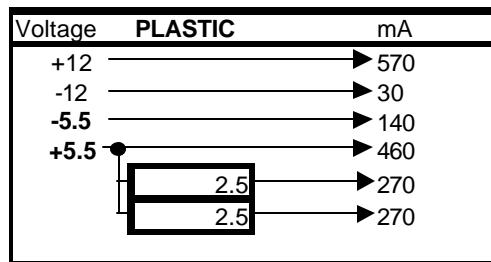
Figure 2-1 LVPS Voltage/Current Requirements



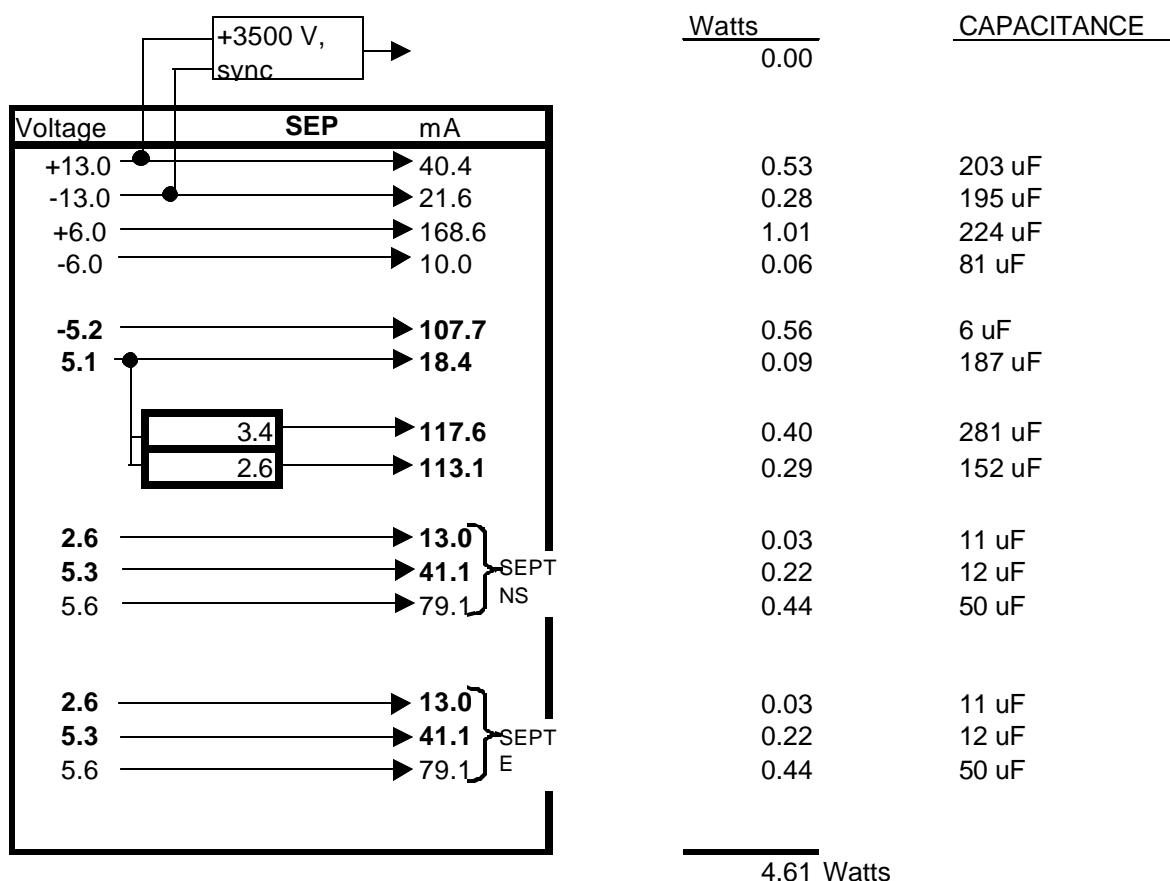
WATTS	SURGE	CAPACITANCE
0.19		6.8uF+MAG
0.19	1.28 Watts	6.8uF+MAG
		-
0.08		75uF
0.08		75uF
3.00		51uF+MAG
	3.50 Watts	5uF
0.10		31uF
3.63 Watts		8.41 Watts w/ surge

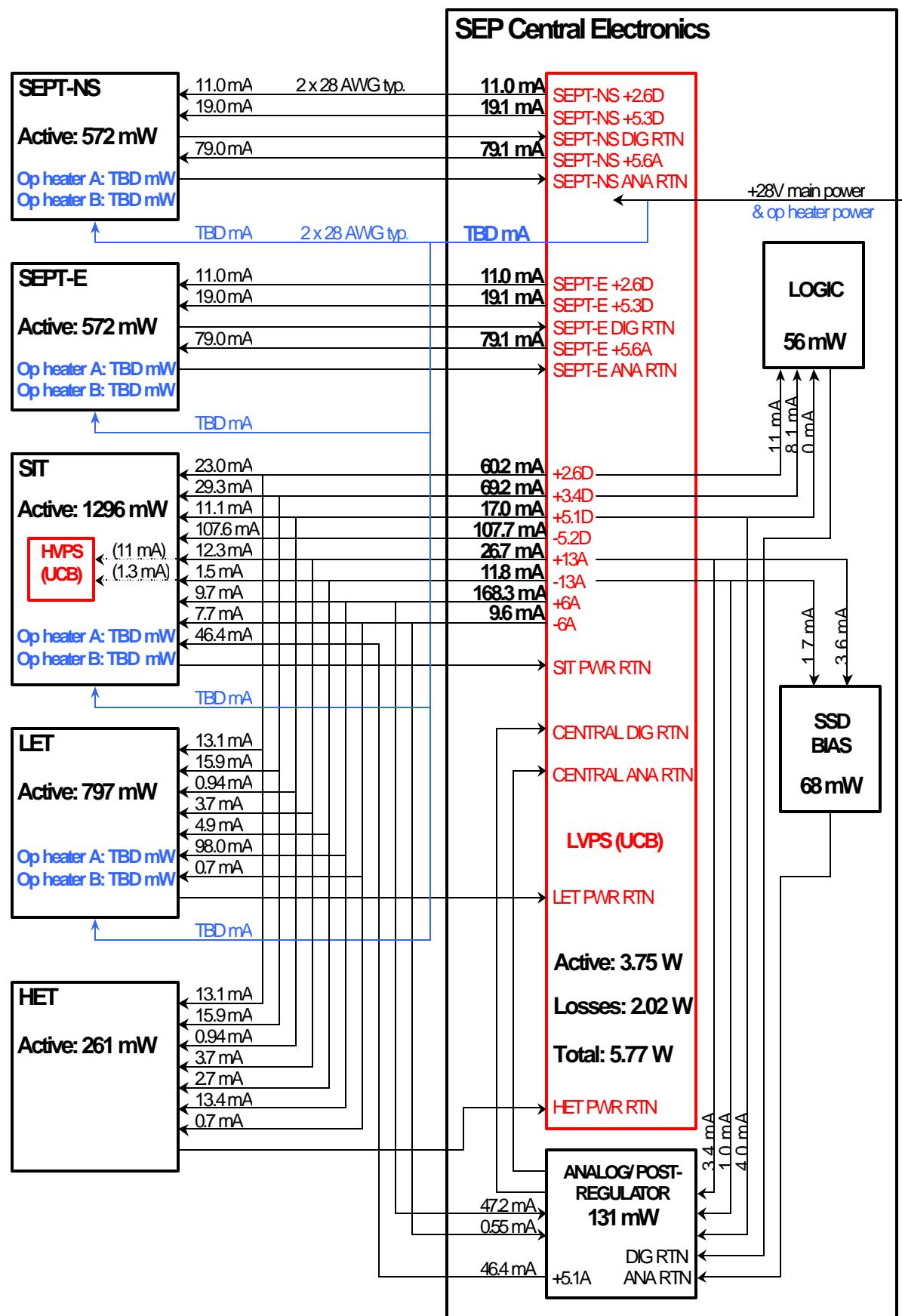


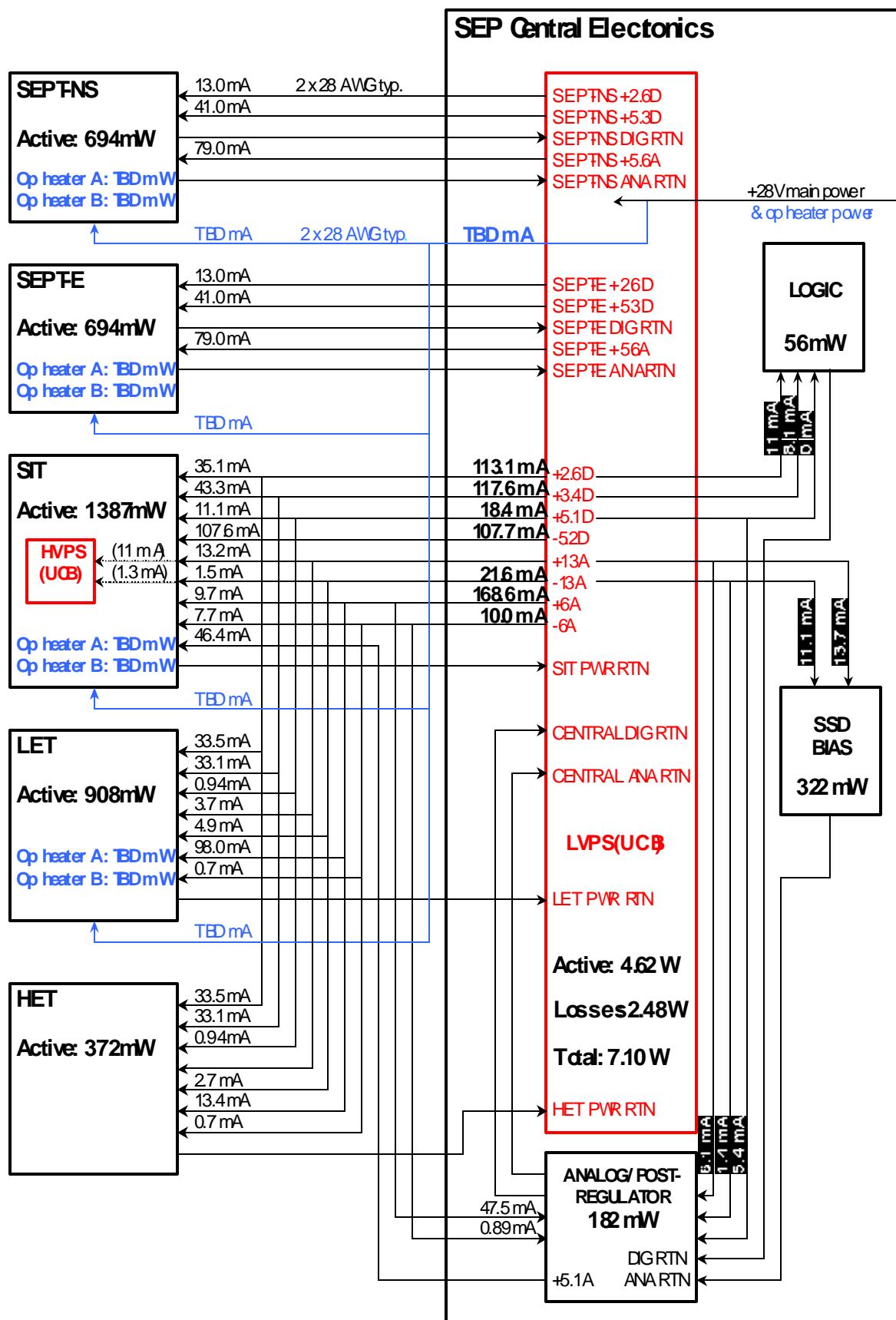
WATTS	SURGE	CAPACITANCE
		-
0.36		4.7uF
0.12		7.8uF
	1.20 Watts	
0.10		7.8uF
0.06		75uF
0.06		75uF
0.10		34uF
0.10		0.7uF
0.90 Watts		2.10 Watts w/ surge



WATTS	SURGE	CAPACITANCE
6.84		25uF
0.36		20uF
0.77		20uF
2.53		30uF
0.68		?
0.68		25uF
11.85 Watts	(includes test port)	







SEP Power Flow (Max)

02/26/03

Figure 2-1b SEP Power Flow Diagram, MAX

SEP minimum (nominal) power per voltage line													2/26/2003		
Consum.	Volt. [V]	Comment	SEPT [mA]	SEPT [mW]	SIT [mA]	SIT [mW]	LET [mA]	LET [mW]	HET [mA]	HET [mW]	Central [mA]	Central [mW]	SEP total [mA]	SEP total [mW]	LVPS output [V]
	+2.6	Digital-NS	11.0	29									11.0	29	+2.6
	+5.3	Digital-NS	19.0	101							0.085	0	19.1	101	+5.3
	+5.6	Analog-NS	79.0	442							0.085	0	79.1	443	+5.6
	+2.6	Digital-E	11.0	29							0.085	0	11.0	29	+2.6
	+5.3	Digital-E	19.0	101							0.085	0	19.1	101	+5.3
	+5.6	Analog-E	79.0	442							0.085	0	79.1	443	+5.6
	+2.6	Digital		23.0	60	13.1	34	13.1	34	11.0	29	60.2	157	+2.6	
	+3.4	Digital		29.3	100	15.9	54	15.9	54	8.1	28	69.2	235	+3.4	
	+5.1	Digital		11.1	57	0.94	5	0.94	5	4.0	20	17.0	87	+5.1	
	-5.2	Digital		107.6	560					0.085	0	107.7	560	-5.2	
	+13	Analog		12.3	160	3.7	48	3.7	48	7.0	91	26.7	347	+13	
	-13	Analog		1.5	20	4.9	64	2.7	35	2.7	35	11.8	153	-13	
	+6	Analog		9.7	58	98.0	588	13.4	80	47.2	283	168.3	1010	+6	
	-6	Analog		7.7	46	0.7	4	0.7	4	0.5	3	9.6	58	-6	
Regulator	+5.1	Analog		46.4	237	97.2	496	12.6	64						From +6
	Instr. subtotal:		1143		1296		797		261		255		3752		
	One half:		571.7										2020	2020	
LVPS @ 65% efficiency:															
	SEP total:												2275	5772	
SEP maximum power per voltage line													2/26/2003		
Consum.	Volt. [V]	Comment	SEPT [mA]	SEPT [mW]	SIT [mA]	SIT [mW]	LET [mA]	LET [mW]	HET [mA]	HET [mW]	Central [mA]	Central [mW]	SEP total [mA]	SEP total [mW]	LVPS output [V]
	+2.6	Digital-NS	13.0	34									13.0	34	+2.6
	+5.3	Digital-NS	41.0	217							0.085	0	41.1	218	+5.3
	+5.6	Analog-NS	79.0	442							0.085	0	79.1	443	+5.6
	+2.6	Digital-E	13.0	34									13.0	34	+2.6
	+5.3	Digital-E	41.0	217							0.085	0	41.1	218	+5.3
	+5.6	Analog-E	79.0	442							0.085	0	79.1	443	+5.6
	+2.6	Digital		35.1	91	33.5	87	33.5	87	11.0	29	113.1	294	+2.6	
	+3.4	Digital		43.3	147	33.1	112	33.1	112	8.1	28	117.6	400	+3.4	
	+5.1	Digital		11.1	57	0.94	5	0.94	5	5.4	28	18.4	94	+5.1	
	-5.2	Digital		107.6	560					0.085	0	107.7	560	-5.2	
	+13	Analog		13.2	172	3.7	48	3.7	48	19.8	257	40.4	525	+13	
	-13	Analog		1.5	20	4.9	64	2.7	35	12.5	162	21.6	281	-13	
	+6	Analog		9.7	58	98.0	588	13.4	80	47.5	285	168.6	1012	+6	
	-6	Analog		7.7	46	0.7	4	0.7	4	0.9	5	10.0	60	-6	
	+5.1	Analog		46.4	237	97.2	496	12.6	64						From +6
	Instr. subtotal:		1387		1387		908		372		559		4614		
	One half:		693.5										2484	2484	
LVPS @ 65% efficiency:															
	SEP total:												3044	7098	

Figure 2-1c, SEP Min/Max Power Requirements

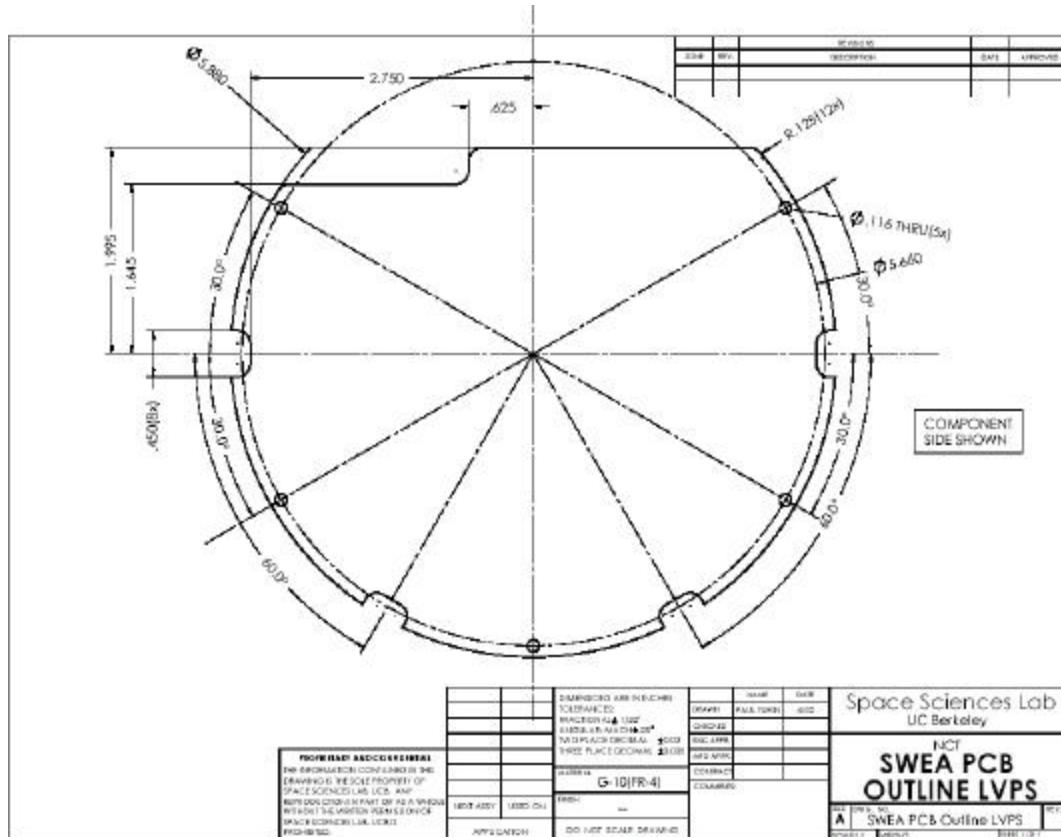


Figure 2-2 SWEA LVPS Form Factor

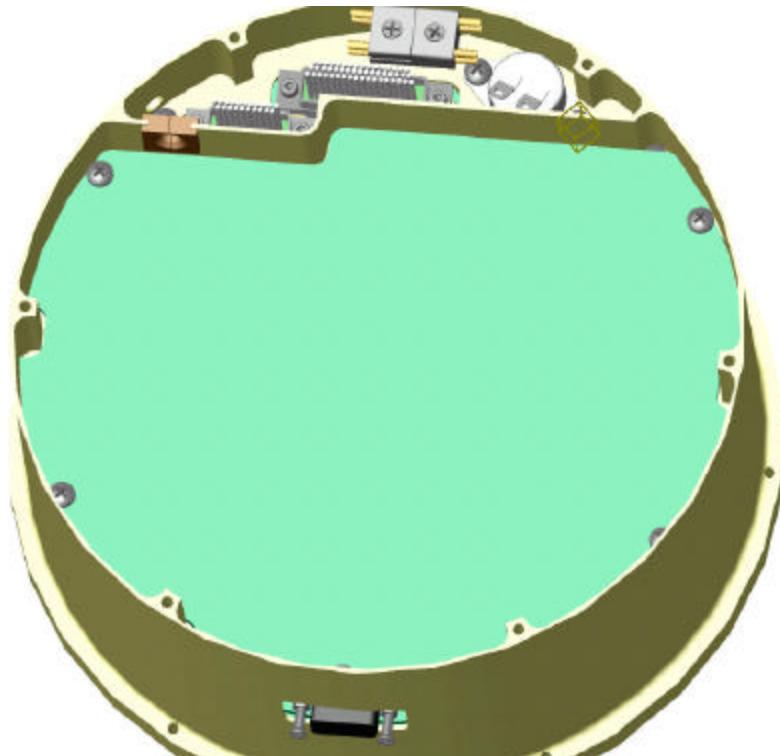


Figure 2-3 SWEA LVPS Form Factor

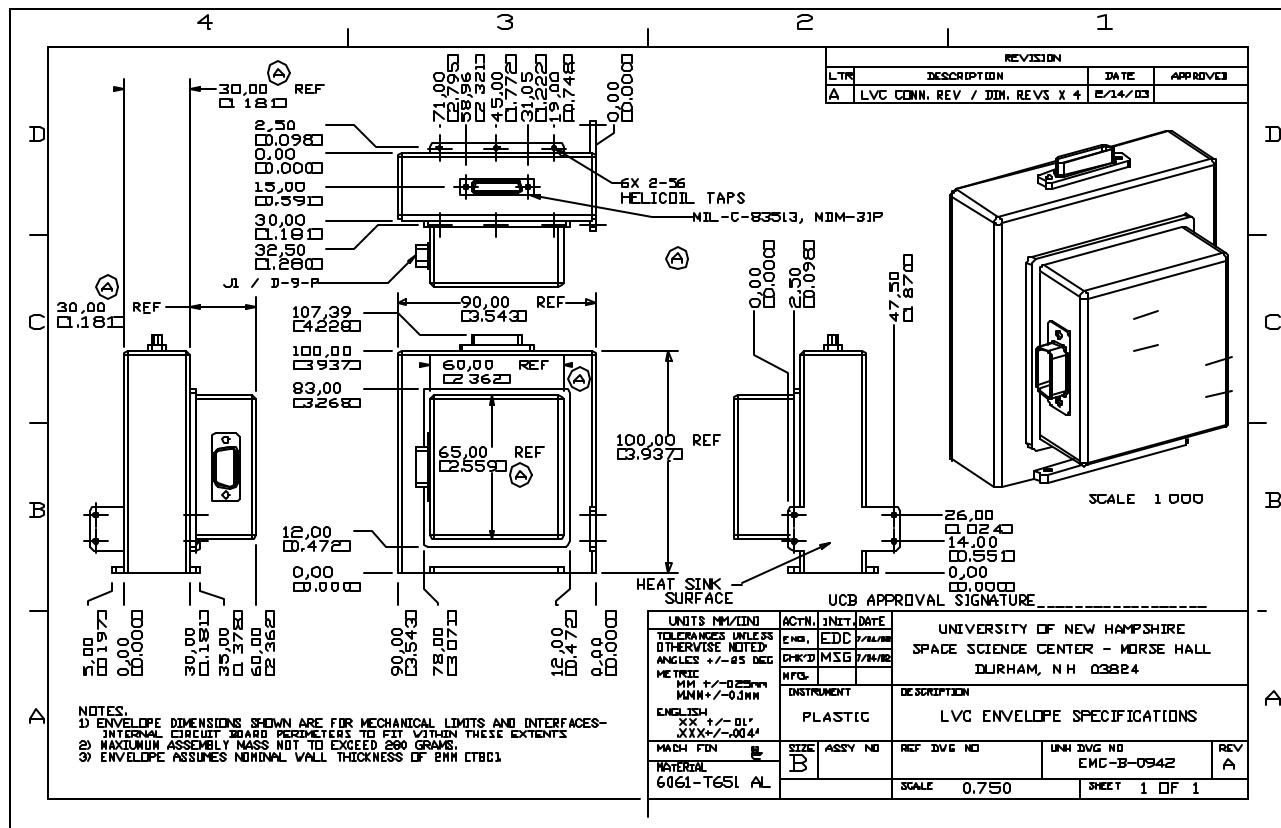


Figure 2-4, PLASTIC LVPS Form Factor

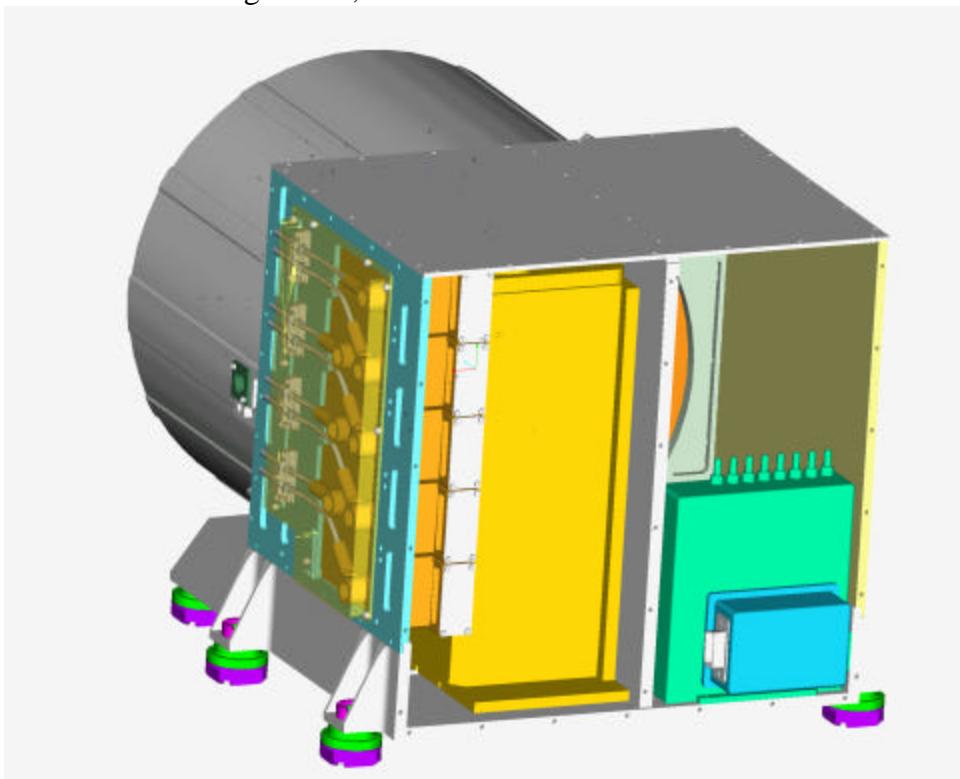


Figure 2-5, PLASTIC LVPS shown in PLASTIC

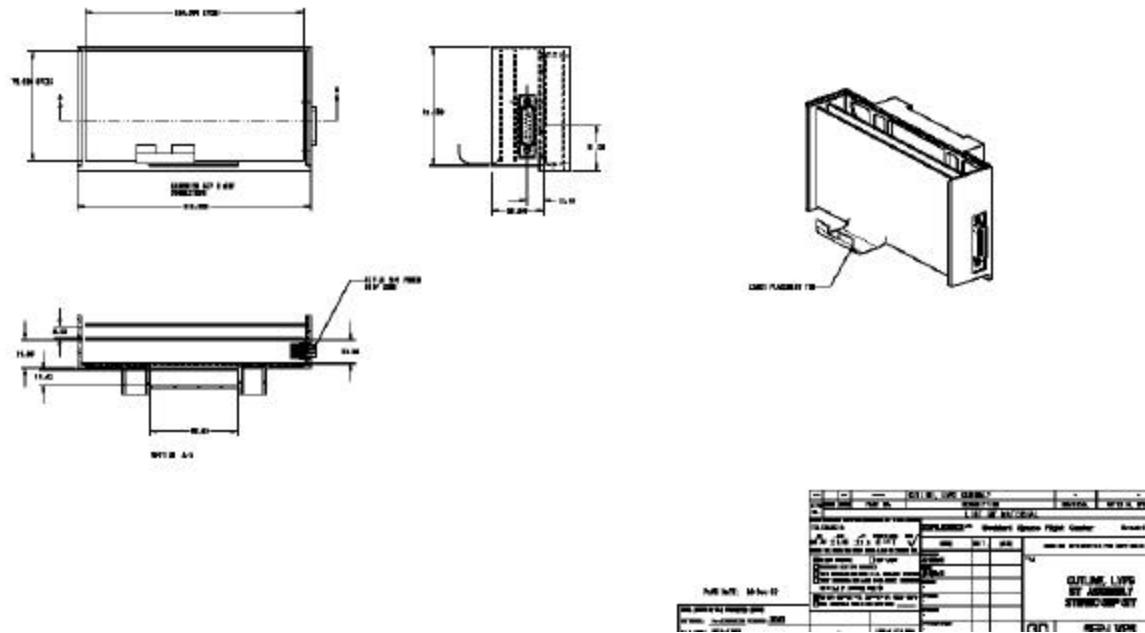


Figure 2-6 SEP LVPS form factor

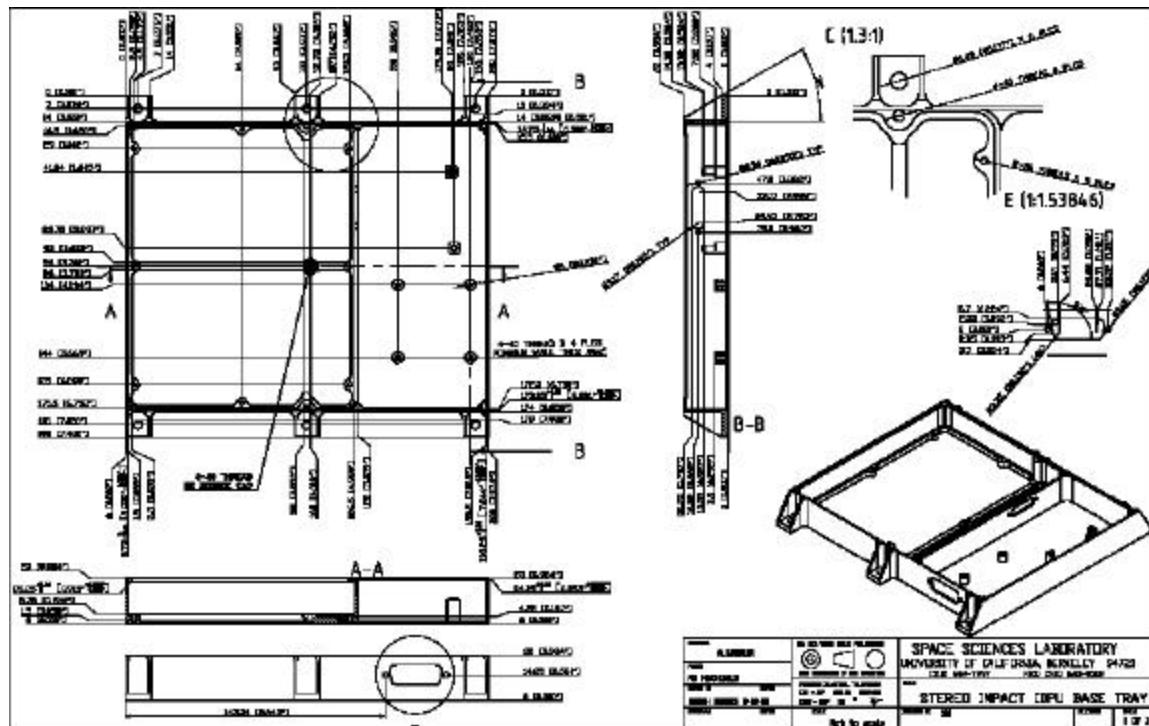


Figure 2-7 IDPU LVPS Form Factor

Airborn M83513/04-C11N (on a pig-tail attached to the LVPS)

Pin	Signal
17	STE Bias Return
16	STE Bias (140V)
7,8	Digital Ground
14	VCC_A (2.5V)
6	+5VD
13,15,9,10	Analog Ground
20	+5.1VA
18	-5.1VA
10	+12.1VA
21	-12.1VA
5	+28V (secondary)
1	+28V primary
11	+28V primary Return
12	SWEA Temp Sensor
3	SWEA Temp Sensor Return
2	+28V Heater
4	+28V Heater Return

Note: Pins 2,3,4,12 do not route to the LVPS. They go from the DAC board to a Winchester connector mounted to the chassis outside the LVPS

Figure 2-8 SWEA LVPS Connector Pinout

SEP LVPS connectors**2/11/2003**

Internal to SEP		Internal to SEP
SEP-P19A		SEP-P19B
LVPS output		LVPS output
1	SEPT-NS ANA RTN	52 HET +13A
2	SEPT-NS ANA RTN	53 HET +6A
3	SEPT-NS +5.6A	54 HET +6A
4	SEPT-NS +5.6A	55 HET -6A
5	Spare	56 HET -6A
6	Spare	57 HET -13A
7	SEPT-NS DIG RTN	58 HET -13A
8	SEPT-NS DIG RTN	59 HET +2.6D
9	SEPT-NS +2.6D	60 HET +2.6D
10	SEPT-NS +2.6D	61 HET +3.4D
11	SEPT-NS +5.3D	62 HET +3.4D
12	SEPT-NS +5.3D	63 HET +5.1D
13	SEPT-NS SEP STAR	64 HET +5.1D
14	SEPT-NS SEP STAR	65 Spare
15	SEPT-E ANA RTN	
16	SEPT-E ANA RTN	
17	SEPT-E +5.6A	
18	SEPT-E +5.6A	
19	Spare	
20	Spare	
21	SEPT-E DIG RTN	
22	SEPT-E DIG RTN	
23	SEPT-E +2.6D	
24	SEPT-E +2.6D	
25	SEPT-E +5.3D	
26	SEPT-E +5.3D	
27	SEPT-E SEP STAR	
28	SEPT-E SEP STAR	
29	SIT PWR RTN	
30	SIT PWR RTN	
31	SIT +13A	
32	SIT +13A	
33	SIT +6A	
34	SIT +6A	
35	Spare	
36	Spare	
37	SIT -6A	SEP-P19A Nanonics P/N:
38	SIT -6A	EM STM065C6N
39	SIT -13A	Flight 94036CD065002SE2
40	SIT -13A	65-pin, TH, horizontal plug, located on flex
41	SIT -5.2D	
42	SIT -5.2D	
43	SIT +2.6D	SEP-P19B Nanonics P/N:
44	SIT +2.6D	EM STM051C6N
45	SIT +3.4D	Flight 94036CD051002SE2
46	SIT +3.4D	51-pin, TH, horizontal plug, located on flex
47	SIT +5.1D	
48	SIT +5.1D	
49	HET PWR RTN	
50	HET PWR RTN	
51	HET +13A	
External to SEP		
SEP-J1		18 CENTRAL DIG RTN
S/C power & heaters		19 CENTRAL DIG RTN
1	Spare	20 CENTRAL +2.6D
2	+28V MAIN/OP HTR	21 CENTRAL +2.6D
3	+28V MAIN/OP HTR	22 CENTRAL +3.4D
4	Spare	23 CENTRAL +3.4D
5	+28V SURV HTR	24 CENTRAL +5.1D
6	+28V SURV HTR	25 CENTRAL +5.1D
7	Spare	26 CENTRAL ANA RTN
8	CHASSIS	27 CENTRAL ANA RTN
9	Spare	28 CENTRAL ANA RTN
10	+28V MAIN/OP HTR RTN	29 CENTRAL ANA RTN
11	+28V MAIN/OP HTR RTN	30 CENTRAL +13A
12	Spare	31 CENTRAL +13A
13	+28V SURV HTR RTN	32 CENTRAL +6A
14	+28V SURV HTR RTN	33 CENTRAL +6A
15	Spare	34 CENTRAL -6A
		35 CENTRAL -6A
		36 CENTRAL -13A
		37 CENTRAL -13A
		38 LVPS TEMP SENSOR
		39 Spare
		40 Spare
		41 Spare
		42 Spare
		43 Spare
		44 +28V SURV HTR RTN
		45 +28V SURV HTR RTN
		46 +28V SURV HTR
		47 +28V SURV HTR
		48 +28V OP HTR
		49 +28V OP HTR
		50 +28V OP HTR RTN
		51 +28V OP HTR RTN

Figure 2-9 SEP LVPS Connector pinouts

Low Voltage Convertor Pin Assignment

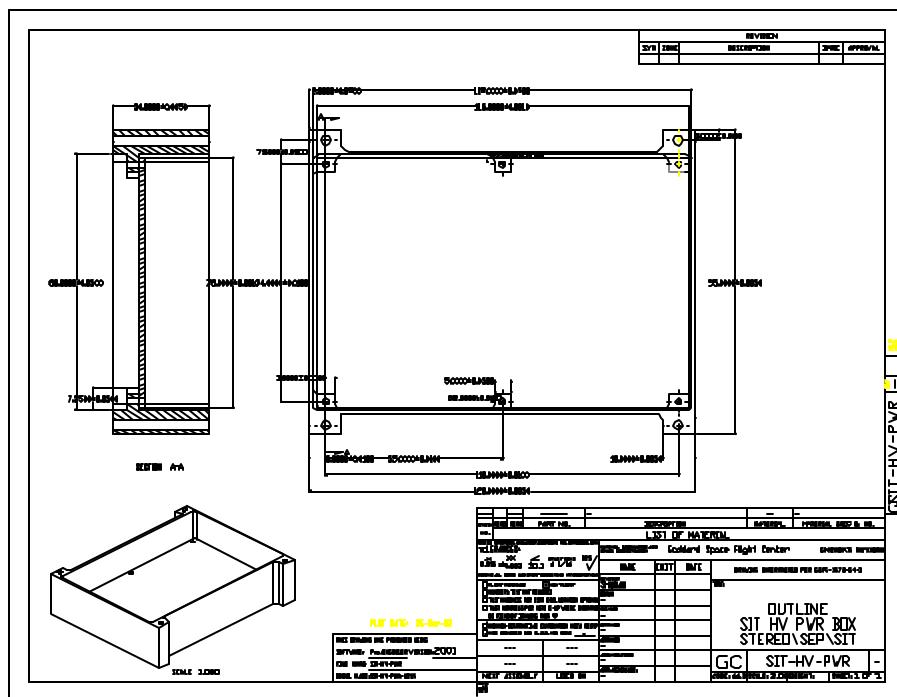
<u>Pin #</u>	<u>Assignment</u>	<u>Part</u>
1	+12V	
2	+12V	
3	+12V	
4	-12V	
5	-12V	ITT Cannon.
6	-12V	M8513/ 04 - E 09 N
7	+5.5V	Receptacle
8	+5.5V	
9	+5.5V	
10	-5.5V	<u>Wire Size</u>
11	-5.5V	26 Awg
12	-5.5V	
13	+2.5V_A	
14	+2.5V_A	
15	+2.5V_A	
16	+2.5V_B	
17	AGND	
18	AGND	
19	AGND	
20	AGND	
21	AGND	
22	AGND	
23	AGND	
24	AGND	
25	AGND	
26	AGND	
27	AGND	
28	SPARE	
29	SPARE	
30	+2.5V_B	
31	+2.5V_B	

Figure 2-10 PLASTIC LVPS Converter pinout (output).

3. SIT HVPS Requirements

The SIT HVPS is part of the SIT instrument. It takes secondary +/- 12V and generates a programmable output voltage at up to +3500V plus a number of proportional taps. This supply provides no ground isolation, and does not need to meet the conducted EMC requirements of reference 1. Detailed electrical requirements are described in reference 5.

3.1. *Form Factor*



3.2. *Connectors*

The input connector is described in reference 5. The output shall be un-terminated wires which shall be terminated in the SIT instrument. The wires must be shielded in a continuous fashion between the boxes providing no gap.